



Atty.Dckt.No.: 2001P14591US

ASSIGNMENT

For good and valuable consideration, We, Infineon Technologies North America Corp., hereinafter referred to as Assignor, hereby sells, assigns and transfers to Infineon Technologies AG, a corporation, organized and existing under the laws of Germany, having its principal place of business at St. Martin Str. 53, 81541 Munich, Germany,

hereinafter referred to as Assignee, its successors, assigns and legal representatives, the entire right, title and interest, in and for the United States and all foreign countries, in and to any and all inventions which are disclosed in the application for United States Letters patent, and which was recorded on reel 012929, frame 0958 on May 23, 2002;

Serial No.: 10/084,194

Filed: February 28, 2002

and entitled: Integration Scheme For Metal Gap Fill With Fixed Abrasive CMP

in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said inventions; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said inventions;

Assignor agrees that Assignee may apply for and receive Letters Patent for said inventions in its own name;

Assignor agrees that, at the request of the Assignee and, without charge to but at the expense of said Assignee, Assignor will carry out in good faith the intent and purpose of this Assignment; execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said inventions; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to Assignee, all facts known to the undersigned relating to said inventions and the history thereof; and generally do everything possible which Assignee shall consider desirable for aiding in securing and mainlining proper patent protection for said inventions and for vesting title to said inventions, and all applications for patents and all patents on inventions in said Assignee;

**PATENT**  
**REEL: 013424 FRAME: 0758**

Atty.Dckt.No.: 2001P14591US

-2-

Covenant with Assignee that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Infineon Technologies North America Corp.

*Gregory Bibbes*  
Gregory Bibbes  
Its Secretary Duly Authorized

State of California )  
County of Santa Clara )

On this 27 day of January 2003, before me, the undersigned Notary Public, duly commissioned and sworn, personally appeared Gregory Bibbes,

X personally known to me  
           proved to me on the basis of satisfactory evidence to be the person(s) whose name(s) is subscribed to the within instrument, and acknowledged that he executed it in his authorized capacity on behalf of the corporation named therein, and that by his signature on the instrument that such corporation executed the same.

WITNESS my hand and official seal.

*Elaine Gonzales*  
Notary Public

